

Student Guide for Tuition Fee Loan Application



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1 Apply for Tuition Fee Loan

Prerequisite: Only matriculated students will be able to apply for the Tuition Fee Loan. For international students, only those who apply for Tuition Grant are eligible to apply for the loan.

Basic flow of the Tuition Fee Loan Application:

- 1. Apply for Tuition Fee Loan through IN4SIT.
- 2. Print the application form upon submission of application in IN4SIT.
- 3. For late application, print and submit the letter of late endorsement along with the application form (to any DBS branch only).
- 4. Submit the application form, letter of late endorsement (for late application), and all necessary documentation to the bank along with the guarantor for the loan.
- 5. Upon successful application at the bank, update the bank submission details in IN4SIT to update that the application has been completed.

1.1 Signing in

The steps below are required to apply for Tuition Fee Loan:

- 1. Open the browser (i.e. Internet Explorer)
- 2. Type the URL of IN4SIT in the browser address box.
- 3. Enter your login credentials, then click on Sign In button or press Enter key.

NB: User ID and Password are case sensitive

SiT	SINGAPORE INSTITUTE OF TECHNOLOGY
User ID 1 Password Sign In	This Service is for Authorised Users Only By logging in, you agree to be bound by the Terms and Conditions.

4. Successful sign in will redirect user to the homepage of IN4SIT.





1.2 Navigating to the Page

1. Click on Financial Aid and Scholarships tile in the homepage of SIS.



2. **Financial Aid Application** page will be displayed by default. This page is to apply for Financial Aid in SIS. To apply for Tuition Fee Loan, click on **Loans Application** on the sidebar menu of the page.

	Fina	ncial Aid Application		Â	=
Financial Application	Application Management Your Applications Application Date \Diamond	Application Nbr \diamond	Status 🗘	>	Î
	Application Periods	Application Start Date 🛇	Application End Date ≎		
	Abwin Study Grant	24/05/2017	30/09/2017		
	ATEO Bursary	24/05/2017	30/09/2017	1	
	Choo Chiau Beng Bursary	24/05/2017	30/09/2017		
	Dou Yee Enterprises Bursary	24/05/2017	30/09/2017		
	Drilmaco Bursary	24/05/2017	30/09/2017		
	Feinmetall Bursary	24/05/2017	30/09/2017		
		New Application			*



3. System will redirect user to the Loan Application page. By default, **Tuition Fee Loan Application** page will be displayed.

ST	Financial Aid and Scholarships	â	=		
Tuition Fee Loan Application	Tuition Fee Loan		_		
Study Loan Application	Instructions The Tuilion Fee Loan covers up to 90% of subsidized fees navable by Singanore Citizens				
OSP Loan Application	Please refer to DBS Tuition Fee Loan for more information such as the application period, eligibility criteria, guarantor requirements and loan repayment.				
Financial Aid Application	Instructions for application: 1. Click on New Application' and complete the application form. You may only submit the form ONCE. 2. Print the application form and complete the necessary formalities at the nearest DBS Branch with your guarantor.				
Sign Out	2. Update you'r Bank Submission Details after application has been endorsed by Bank Officer. 4. If you have missed the application period, please print the Letter Of Late Endorsement and submit II with your application form. For enquires on application, please contact Admissions Division at 0592 1150 during office hours or write to FAS@SingaporeTech.edu.sg. If you wish to consider other loan schemes to assist with the payment of your tuition fees and other education expenses, please visit http://www.singaporetech.edu.sg/fees/loans for more details. Your Applications				
	You do not have any Tultion Fee Loan Application at the moment.				
	New Application				

1.3 Starting New Application

1. Click on **New Application** button on the bottom of the page.

51	Financial Aid and Scholarships	â	Ξ			
Tuition Fee Loan Application	Tuition Fee Loan					
Study Loan Application	Instructions The Tuition Eco Loop square up to 00% of subsidiaried food equiphle by Singapore Officials					
OSP Loan Application	Please refer to DBS Tuition Fee Loan for more information such as the application period, eligibility criteria, guarantor requirements and loan repayment	1L				
Financial Aid Application	Instructions for application: 1. Click on 'New Application' and complete the application form. You may only submit the form ONCE. 2. Print the apolication form and complete the necessary formalities at the nearest DBS Branch with your guarantor.					
Sign Out	Update your Bank Submission Details after application has been endorsed by Bank Officer If you have missed the application period, please print the Letter of Late Endorsement and submit it with your application form.					
	For enquiries on application, please contact Admissions Division at 6592 1150 during office hours or write to FAS@SingaporeTech.edu.sg. If you wish to consider other loan schemes to assist with the payment of your tuition fees and other education expenses, please visit. http://www.singaporetech.edu.sg/tees/loans for more details.					
	Your Applications					
	You do not have any Tuition Fee Loan Application at the moment.					
	New Application (hg					

2. Students will see their personal particulars in the page. For Singapore Citizen and Singapore Permanent Resident, all values will be read only as it is coming from the system. However, for International Student, some fields are editable and require students to enter the necessary information, e.g.: Passport Information (as the identity number in applying for Ioan), Singapore Address (Block/House No, Street Name, Floor No, Unit No), and Overseas Address (Overseas Address 1, 2, 3, 4).

Field Name	Required?	Comments
	(Yes/No)	
Passport Number	Yes	Field to capture the passport number of the international student.
Passport Expiry Date	Yes	Field to capture the expiry date of the passport.
Country Issuing Passport	Yes	Field to capture the country issuing passport.



Field Name	Required? (Yes/No)	Comments
Block/House No	Yes	Field to capture the block/house number of the Singapore Address where the international student stays.
Street Name	No	Field to capture the street name of the Singapore Address where the international student stays.
Floor	No	Field to capture the floor number of the Singapore Address where the international student stays.
Unit No	No	Field to capture the unit number of the Singapore Address where the international student stays.
Overseas Address 1	Yes	Field to capture the overseas home address of the international student.
Overseas Address 2	No	Field to capture the overseas home address of the international student.
Overseas Address 3	No	Field to capture the overseas home address of the international student.
Overseas Address 4	No	Field to capture the overseas home address of the international student.

Singapore Citizen and Permanent Resident page display





International Student page display

ST	Financial A	id and Scholarships 🔗
Tuition Fee Loan Application	Tuition Fee Loan	
Study Lean Application	Step 1 of 4 : Particular of Borrower	
Study Loan Application	Name	Sample Student
OSP Loan Application	University Name	Singapore Institute of Technology
Einansial Aid Application	Academic Career	Undergraduate
Timencial Ald Application	Academic Program	BEng (Hons) ICT (Software Engineering)
Sign Out	Year of Study	2
	Matriculation Number	X000000X
	Marital Status	Single
	Date of Birth	DD/MM/YYYY
	Residency	International Student
	Citizenship	Malaysia
	*Passport Number	
	"Passport Expiry Date	
	*Country Issuing Passport	
	Home Phone #	9999999
	*Block/House No.	XX
	Street Name	BEDOK SOUTH AVE 3
	Floor	XX
	Unit No.	XX
	Postal Code	XXXXXXX
	*Overseas Address 1	
	Overseas Address 2	
	Overseas Address 3	
	Overseas Address 4	
	Email Address	TEST.TEST@TEST.COM
	Please ensure all fields entered are accurate. If y to have the change effected.	ou wish to update your particulars, please write to Registrar's Office at Registrar@SingaporeTech.edu.sg
	For more information on TFL, please refer to http	://www.singaporetech.edu.sg/tuition-fee-loan .
	Back	Save Next

Verify that all information displayed or entered are correct before continuing the application. **IMPORTANT!** If there are any discrepancies found in the student particulars, do not proceed with the application. Instead, contact the Registrar Office to update your particulars prior to completing the application.

After verification is done, click on **Next** button to continue to the next step. A message box will be displayed to notify student about the particulars update to be made in Registrar Office.

Any data entered, edited, or displayed in this page will only be used for appl	lication form purpose. It will not modify the existing data in the system.
Please write to Registrar's Office at Registrar@SingaporeTech.edu	I sg with your updated particulars to have the change effected.
ОК	Cancel

Click on **OK** button and system will redirect to the next step of the application.

3. In this step, student will be required to choose the financing required needed under the Tuition Fee Loan. There are 4 options available in this page. Select the loan option you are intending to apply for. For option '**Other Percentage**', student is required to enter the percentage required which is not in the other 3 options. The maximum limit is 90%.



	Financial Aid and Scholarships	â	E		
Tuition Fee Loan Application	Tuition Fee Loan				
Study Loan Application	Step 2 of 4 : Financing Required				
OSP Loan Application	Loan Quantum (please tick as appropriate) : The main of the state of				
Financial Aid Application	50% of the tuition fee payable for the remaining course of study.				
Sign Out	Other percentage of the tuition fees payable for the remaining course of study.				
	The Tuition Fee Loan covers up to 90% of subsidized fees payable by Singapore Citizens. For more information on TFL, please refer to https://www.singaporetech.edu.sg/fees/tuition-fee-loan.				
	Back Save Next (h,				

Upon selection, click on **Next** button to continue to the third step.

4. In this step, students will input the particulars of guarantor who will guarantee the tuition fee loan as below. Required fields are indicated with (*) symbol.

Field Name	Required? (Yes/No)	Comments
Name as in NRIC/Passport	Yes	Field to capture the Guarantor's name.
Date of Birth	Yes	Field to capture the Guarantor's Date of Birth
Marital Status	Yes	Field to capture the Guarantor's Marital Status.
Residency	Yes	Field to capture the Guarantor's residency.
NRIC No.	Yes	Field to capture the Guarantor's NRIC No. if the residency is Singapore Citizen or Singapore Permanent Resident.
Passport No.	Yes	Field to capture the Guarantor's Passport No. if the residency of the guarantor is Foreigner.
Passport Expiry Date	Yes	Field to capture the Guarantor's Passport Expiry Date if the residency of the guarantor is Foreigner.
Country Issuing Passport	Yes	Field to capture the country Issuing Passport if the residency of the guarantor is Foreigner.
Citizenship	Yes	Field to capture the Guarantor's citizenship.
Home Tel No.	Yes	Field to capture the Guarantor's Home Tel No. Student should provide either home telephone or mobile phone number.
Mobile No.	Yes	Field to capture the Guarantor's Mobile No. Student should provide either home telephone or mobile phone number.
Address 1	Yes	Field to capture the Guarantor's Permanent Home Address
Address 2	No	Field to capture the Guarantor's Permanent Home Address
Address 3	No	Field to capture the Guarantor's Permanent Home Address
Address 4	No	Field to capture the Guarantor's Permanent Home Address
Email Address	No	Field to capture the Guarantor's Email Address
Relationship to Applicant	Yes	Field to capture the Guarantor's Relationship to Applicant
Occupation	No	Field to capture the Guarantor's occupation



Field Name	Required?	Comments
	(Yes/No)	
Office Tel No.	No	Field to capture the Guarantor's office telephone no.
Name of Employer	No	Field to capture the Guarantor's employer name
Address of Employer	No	Field to capture the Guarantor's employer address
Are you an undischarged bankrupt?	Yes	Field to capture if the guarantor is an undischarged bankrupt.
Nbr of Student Loan Guaranteed	Yes	Field to capture if the number of student loan guaranteed by the guarantor
Name of Borrower	Yes	Field to capture name of other student that he/she is a guarantor to.
Name of Lender	Yes	Field to capture name of lender that he/she is a guarantor to.
Type of Facility	Yes	Field to capture the type of facility that he/she is a guarantor to
Amount Guaranteed	Yes	Field to capture amount guaranteed for the student stated in Name of Borrower

	Financial A	id and Scholarships	â I
Tuition Fee Loan Application	Tuition Fee Loan		
Study Loan Application	Step 3 of 4 : Particulars of Guarantor		
Study Loan Application	"Name as in NRIC/Passport	Sample Guarantor	
OSP Loan Application	"Marital Status	Married •	
Financial Aid Application	*Date of Birth (between 21 & 60)	01/01/1980	
Sign Out	*Residency	Singapore Citizen •	
	*NRIC No.	XXXXXXXXXXX	
	*Citizenship	Singapore *	
	Home Phone #	69999999	
	Mobile Phone Number	99999999	
	"Address Line 1	Blk 00	
	Address Line 2	Tampines Ave 0	
	Address Line 3	#00-000	
	Address Line 4	Singapore 000000	
	Email Address	TEST.TEST@TEST.COM	
	*Relationship to Applicant	Relative	
	Occupation	Lecturer	
	Office Tel. No.		
	Name of Employer		
	Address of Employer		
	Are you an undischarged bankrupt?	No	
	Nbr of Student Loan Guaranteed	1	
	Name of Borrower \Diamond Name of Ler	nder ◇ Type of Facility ◇	Amount Guaranteed 0
	1 Sample Borrower Sample Len	der Study Loan	12000.00 + -
	Loan application must include one guarantor betw. Nust not be an undischarged bankrupt. No income qualification reguired Must not be an existing guarantor for more than Nationality of guarantor S C quarantor for SC applicant, S C or FR guarantor for PR applicant, S C, FR or foreigner for IS applicant. For more information on TFL, please refer to https:	een 21 – 60 years of age: 1 two (2) students' loans concurrently. ://www.singaporetech.edu.sg/fees/tuition-fee-loan.	
	Back	Save Next In	

Upon entering all the required information, click on **Next** button to continue.

5. Students will need to verify the information from Step 1 to 3 in this page before submission. Please ensure that all information are accurate because students are not allowed to update any information once the application is submitted.



	Financial A	id and Scholarships 😭 🏫
luition Fee Loan Application	Tuition Fee Loan	
Study Loan Application	Step 4 of 4 : Application Summary	
DSP Loan Application	Please ensure all fields below are accurate. If you wish to update your particulars, please write to Registrar's Office at Registrar@SingaporeTech.edu.sg to have the change effected. You will not be able to make changes after you submit the form.	
inancial Aid Application	Particulars of Borrower	
	Name	Sample Student
lign Out	University Name	Singapore Institute of Technology
	Academic Career	Undergraduate
	Academic Program	BEng (Hons) SIE (Land)
	Year of Study	3
	Matriculation Number	XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX
	Marital Status	Single
	Date of Birth	DD/MM/YYYY
	Residency	Singapore Citizen
	Citizenship	Singapore
	NRIC No.	X000000X

Once the verification is done, click on **Submit** button. Click on **Yes** button when a confirmation prompt box appears in the page as below. This is the final step of applying Tuition Fee Loan through IN4SIT.

NB: Maximum Loan Quantum permi	itted is only 90% of subsidized fees payable by Singapore Citizens.
Are you sure you want to submit	this form? You are not able to edit the form once it is submitted.
	Yes m No

1.4 Dealing with Submitted Application

If a student continues from section 2.3 above, by default, system will redirect to the **Application Summary** page as below.

	Financial Aid and Scholarships	۸	≡
Tuition Fee Loan Application	Application Details		_
Study Loan Application	Your application is successfully submitted. Please take note of the application details. Loan Application Number TFL171000031		
OSP Loan Application	Loan Application Date 28/09/2017		
Financial Aid Application	Application Status Not Submitted to Bank Please proceed to print and submit the Application Form to the bank with your guarantor to complete the loan application.		
Sign Out	View Summary		
	Please print the application form by clicking the below button. If you have missed the application period, please print and submit the Letter of Late Endorsement together with your application form. Application Form Letter of Late Endorsement Update Bank Submission Details		
	Please update your bank submission details after you have completed your loan application at the bank. Bank ID Branch ID Submitted Date Update Details		
	Return to Home		

For students who have submitted the application but then sign out or move to any other page in the system, they can still access the **Application Summary** page above by redoing the steps in section 2.1 (if students have signed out from system) and section 2.2. For students who have submitted the application in SIS, the display of page in section 2.2 step 3 will be different. It will be displayed as below.



	Fi	nancial Aid and Scholarships	Â
Tuition Fee Loan Application	Tuition Fee Loan		
Study Loan Application	Instructions The Tuition Fee Loan covers up to 9	0% of subsidized fees payable by Singapore Citizens.	
OSP Loan Application	Please refer to DBS Tuition Fee Loa	n for more information such as the application period, eligi	ibility criteria, guarantor requirements and loan repayment.
Financial Aid Application	Instructions for application: 1. Click on "New Application" and co 2. Print the application form and com	mplete the application form. You may only submit the form plete the necessary formalities at the nearest DBS Brancl	n ONCE. h with your guarantor.
Sign Out	S. Update your sams Submission De S. Update your sams Submission De S. If you have missed the application For enquiries on application, please If you wish to consider other loan sch http://www.singaporetech.edu.sg/fee Your Applications	tails are application has been enclosed by bank Ottocr, period, please print the Letter of Late Endorsement and s contact Admissions Division at 6592 1150 during office ho remes to assist with the payment of your tuition fees and c siloans for more details.	submit it with your application form. urs or write to FAS@SingaporeTech edu sg. other education expenses, please visit
	Loan Application Date 🛇	Loan Application Number \Diamond	Application Status 🗘
	28/09/2017	TFL171000031	Not Submitted to Bank
	<u>.</u>		<u>_</u>
		New Application	

Click on the row of existing application and it will redirect to the **Application Summary** page again.

Upon submission in the system, the initial application status will be '**Not Submitted to Bank**'. There are at least 4 statuses used for the Tuition Fee Loan application as below:

Status	Description
Draft	Loan application is not submitted in IN4SIT yet. Student initiated the
	application and only saved the application in SIS.
Not Submitted to Bank	Loan application is submitted in IN4SIT, but not submitted to the bank
	yet.
Submitted to Bank	Loan application has been successfully submitted to the bank and the
	bank submission details have been updated in IN4SIT.
Approved by bank	Loan application has been approved by bank.
Rejected	Loan application has been rejected by SIT/bank.

In Application Summary page, student can do the below items:

- View Summary for the Tuition Fee Loan Application
- Print the application form for submission to bank.
- Print the letter of late endorsement for submission to bank in case of late application.
- Update the bank submission details after successful submission to bank.

1.4.1 View Summary of Application

For viewing the summary of the application, click on the '**View Summary**' button in **Application Details** section.



	Financial Aid and Scholarships 🔗 🚍	
Tuition Fee Loan Application	Application Details	
Study Loan Application	Your application is successfully submitted. Please take note of the application details. Loan Application Number TFL171000031	
OSP Loan Application	Loan Application Date 28/09/2017	
Financial Aid Application	Application Status Not Submitted to Bank Please proceed to print and submit the Application Form to the bank with your guarantor to complete the loan application. View Summary	
Sign Out		
	Please print the application form by clicking the below button: If you have missed the application period, please print and automit the Letter of Late Endorsement together with your application form. Application Form	
	Update Bank Submission Details	
	Please update your bank submission details after you have completed your loan application at the bank. Bank ID Branch ID Submitted Date	
	Update Details	
	Return to Home	

System will display all of information submitted during the application in the page. Basically it resembles the Application Confirmation page (Step 4) or the last step before submission. User can click on '**Back'** button to return to **Application Summary** page.

ST	Financial A	Nid and Scholarships 👔 🔒
Tuition Fee Loan Application	Tuition Fee Loan	
Study Loan Application	Particulars of Borrower Name	Sample Student
OSP Loan Application	University Name	Singapore Institute of Technology
Financial Aid Application	Academic Career	Undergraduate
	Academic Program	BEng (Hons) SIE (Land)
Sign Out	Year of Study	3
	Matriculation Number	XXXXXXXX
	Marital Status	Single
	Date of Birth	DD/MM/YYYY
	Residency	Singapore Citizen
	Citizenship	Singapore
	NRIC No.	XXXXXXXX
	Home Phone #	XXXXXXXXX
	Block/House No.	XX
	Street Name	CLEMENTI AVE 1
	Floor	13
		Back (hr

1.4.2 Print Application Form

For printing the application form, click on the 'Application Form' button in Print Forms section.



SIT	Financial Aid and Scholarships 👚 🗎
Tuition Fee Loan Application	Application Details
Study Loan Application	Your application is successfully submitted. Please take note of the application details. Loan Application Number TFL171000031
OSP Loan Application	Loan Application Date 28/09/2017
Financial Aid Application	Application Status Not Submitted to Bank Please proceed to print and submit the Application Form to the bank with your guarantor to complete the loan application.
Sign Out	View Summary
	Print Forms
	Please print the application form by clicking the below button. If you have missed the application period, please print and submit the Letter of Late Endorsement together with your application form.
	Please update your bank submission details after you have completed your loan application at the bank. Bank ID
	Branch ID
	Submitted Date
	Update Details
	Return to Home

A PDF report will be generated to a new tab. Students can save it to their local computer or print it directly. This document will be submitted as hardcopy form to bank staff as part of the application itself.

δÍΤ	SINGAPORE INSTITUTE OF TECHNOLOGY	SINGAPORE INSTITUTE OF TECHNOLO Company Registration No.: 2009/7667D SIT@Dover, 10 Dover Drive Singapore 138683 Tel: 6592 1189 Fax: 6592 1190	
DBS R	Reference: SIT1		
	TUITION FEE LOAN APPLICATION	FORM	
	For Undergraduate Programme	8	
INFOR	RMATION		
1.	Full-time Singapore Citizens (SC), Singapore Permanent Residents (SF enrolled in undergraduate degree programmes at the Singapore Institute Tuition Fee Loan (TFL) under the MOE Tuition Grant Scheme for up (MOE) subsidised tuition fees payable by Singapore Citizens.	PR) and International (IS)(*) students, e of Technology (SIT) may apply for a to 90% of the Ministry of Education's	
2.	The application form should be typewritten or legibly written in BLOCK LET	ITERS.	
3.	This loan requires a guarantor. The guarantor must meet the following or	iteria:	
	 Between the age of 21 to 60 years old. 		
	 Must not be an undischarged bankrupt. 		
	Should not be an existing guarantor for more than two (2) studer acknowledges that he/she is aware of his/her obligations as a guimplications. To avoid any doubt, the guarantor shall be jointly and s loan including any amounts due and owing by the borrower circumstances. DBS may at its sole discretion, permit a person notwithstanding that the person is already an existing guarantor for tw If you are a Singapore Citizen, your guarantor must be a Singapore.	tts' loans concurrently. The guarantor arantor for this loan and its financial everally liable with the borrower for the under the loan. Under exceptional to act as a guarantor of this loan o (2) or more loans concurrently. titzen.	
	· If you are a Singapore Permanent Resident Student, your guara	antor can be a Singapore Citizen or	
	 Permanent Resident. If you are an International Student, your guarantor can be a Singap foreigner (*). 	oore Citizen, Permanent Resident or a	
(*) Only	y for International Students under Academic Year (AY) 2015 August Intake o	nwards.	
INSTRU	UCTIONS		
1.	Applicants and their guarantors are required to visit any branch of the D	BS Bank Ltd (DBS) with:	
	The completed TEL Application Form		
	 A copy of the Letter of Offer for Admission to SIT (for freshm (for students currently enrolled in SIT). 	en) or a photocopy of the student card	
	 Applicant's identity card / valid passport (for Permanent Resident) 	lents and foreigners, passport must be	

1.4.3 Print Letter of Late Endorsement

For printing of the Letter of Late Endorsement, click on the 'Letter of Late Endorsement' button in **Print Forms** section.



SIT	Financial Aid and Scholarships 🔗 🚍
Tuition Fee Loan Application	Application Details
Study Loan Application	Your application is successfully submitted. Please take note of the application details. Loan Application Number TFL171000031
OSP Loan Application	Loan Application Date 28/09/2017
Financial Aid Application	Application Status Not Submitted to Bank Please proceed to print and submit the Application Form to the bank with your guarantor to complete the loan application.
Sign Out	View Summary
	Print Forms
	Please print the application form by clicking the below button. If you have missed the application period, please print and submit the Letter of Late Endorsement together with your application form. Application Form Update Bank Submission Details
	Please update your bank submission details after you have completed your loan application at the bank. Bank ID Branch ID Evaluation
	Update Details
	Return to Home

A PDF report will be generated to a new tab. Students can save it to their local computer or print it directly. This document will be submitted as hardcopy form to bank staff as part of the application itself. This form is only available for printing during the late application period.

SIT SINGAPORE
28 September 2017
To: DBS Bank
Dear Sir/Mdm
LETTER OF LATE ENDORSEMENT FOR TUITION FEE LOAN APPLICATION
This letter is to certify that EXAMPLE , NRIC No. EXAMPLE is a student of the Singapore Institute of Technology. He is currently pursuing the BEng (Hons) SIE (Land) with Singapore Institute of Technology.
The student needs to apply for the Tuition Fee Loan for the payment of tuition fees from Trimester 2 onwards for AY2017/18.
This letter is valid for 7 days from date of issuance.
Please assist with the student's application.
Should you have any queries, please feel free to contact me at 6592 1150.
Thank you.

1.4.4 Update Bank Submission Details

For updating bank submission details, click on the '**Update Details**' button in **Update Bank Submission Details** section.



ST	Financial Aid and Scholarships 🔗 🗧
Tuition Fee Loan Application	Application Details
Study Loan Application	Your application is successfully submitted. Please take note of the application details. Loan Application Number TFL171000031
OSP Loan Application	Loan Application Date 28/09/2017
Financial Aid Application	Application Status Not Submitted to Bank Please proceed to print and submit the Application Form to the bank with your guarantor to complete the Ioan application.
Sign Out	View Summary
	Print Forms
	Please print the application form by clicking the below button. If you have missed the application period, please print and submit the Letter of Late Endorsement together with your application form.
	Application Form Letter of Late Endorsement
	Update Bank Submission Details
	Please update your bank submission details after you have completed your loan application at the bank. Bank ID
	Branch ID
	Submitted Date
	Update Details (h)
	Return to Home

A subpage will be displayed, and students need to enter the bank branch information and the submission date. By default the bank displayed is only DBS Bank. System will also validate that the submission date should not be greater than the current date.

Cancel	Update Bank Submission Details	Save
Bank ID	DBS & Post Office Savings Bank	0
Branch ID	Bras Basah (127)	
Submitted Date	20/09/2017	

Upon entering the required information, click on **Save** button. The Loan Application status will be updated to '**Submitted to Bank**'. The Application Form, Letter of Late Endorsement, and Update Details button will be disabled upon the status change.

Important! Once the bank submission detail is updated by student, the application form and letter of late endorsement are no longer available for printing. Please be very careful <u>NOT</u> to update this information before you confirm that the submission to DBS has been completed.

SIT	Financial Aid and Scholarships	â	≡		
Tuition Fee Loan Application	Application Details				
Study Loan Application	Your application is successfully submitted. Please take note of the application details. Loan Application Number TFL171000031				
OSP Loan Application	Loan Application Date 28/09/2017				
Financial Aid Application	Application Status Submitted to Bank Please proceed to print and submit the Application Form to the bank with your guarantor to complete the loan application.				
Sign Out	View Summary				
	Please print the application form by clicking the below button. If you have missed the application period, please print and submit the Letter of Late Endorsement together with your application form. Application Form Letter of Late Endorsement Update Bank Submission Details Please update your bank submission details after you have completed your lean application at the bank. Bank ID DBS & Post Office Savings Bank Branch ID Bras Basah (127) Submitted Date 20/09/2017. Update Details				
Return to Home					